

Precision measurement of photon detection efficiency of silicon photomultipliers

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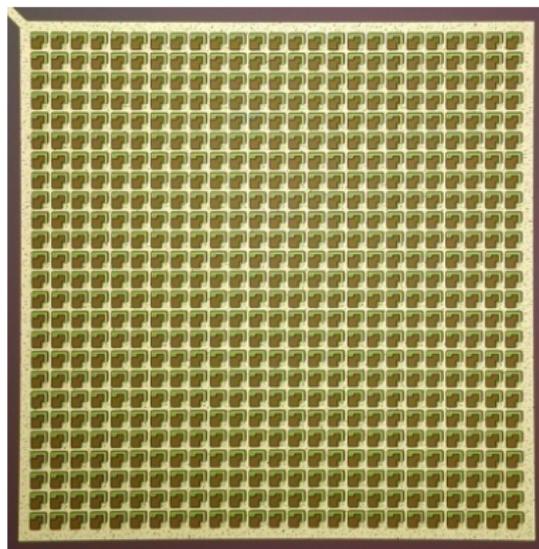
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- 1 Motivation
- 2 Test setup
- 3 Measurements & Results
- 4 Conclusions

Silicon Photomultipliers (SiPM)

- silicon photon detectors made of an array of avalanche photodiodes (APD)
- APDs are operated in Geiger mode (slightly above breakdown voltage)
- incident photon induces an avalanche
- the avalanche is quenched by a decrease of bias voltage over a quenching resistor

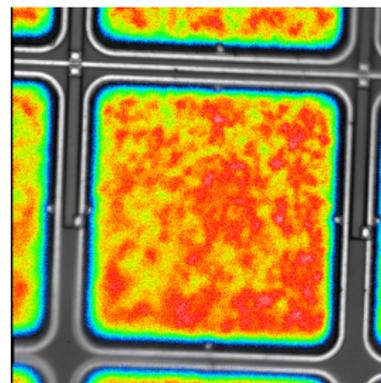
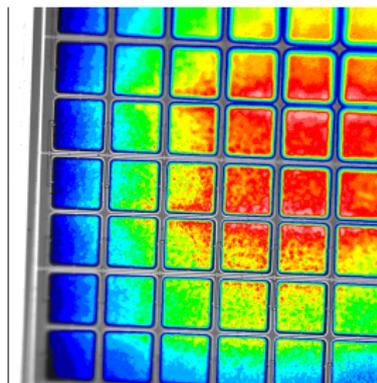
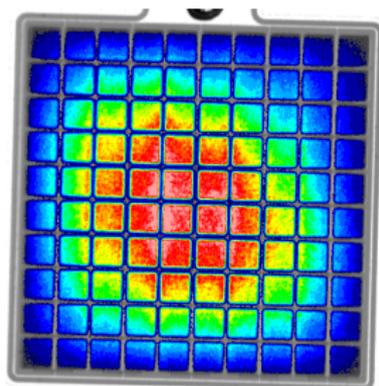


Goal of the study

Ultimate goal

Discovering of sensitivity distribution of a SiPM over its area

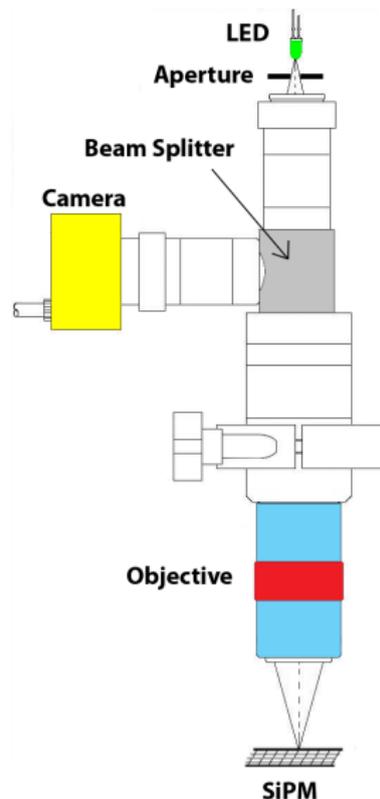
- separating signal from dark count and leakage current
- photon emission measurement is not capable of providing that information
- small light spot size allows us to perform such scan even within a single microcell



Photoemission images

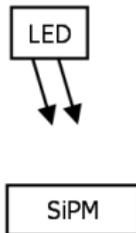
Basic idea of the setup

- light from an LED is focused to a small point ($\phi \sim 1.5 \mu\text{m}$)
- the LED is pulsed (10 ns long pulses, 10 000 shots per step)
- SiPM response is measured in coincidence with LED pulses
- the light beam is driven through any part a SiPM matrix in discrete steps ($\geq 2 \mu\text{m}$)
- a sensitivity scan of a $1 \times 1 \text{ mm}^2$ device with $2 \mu\text{m}$ step size can be completed in ~ 10 hours



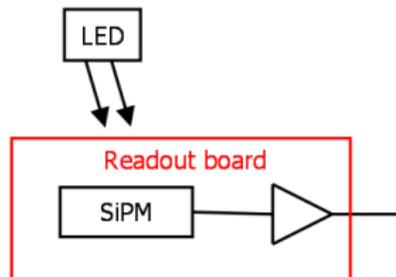
Block scheme

Measurement process



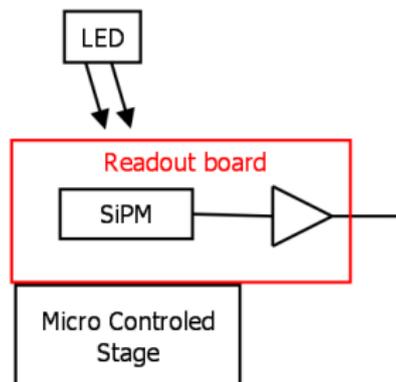
Block scheme

Measurement process



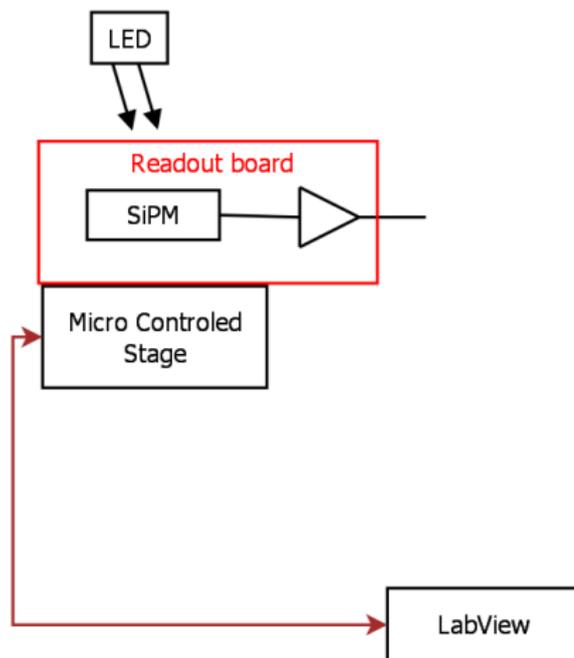
Block scheme

Measurement process



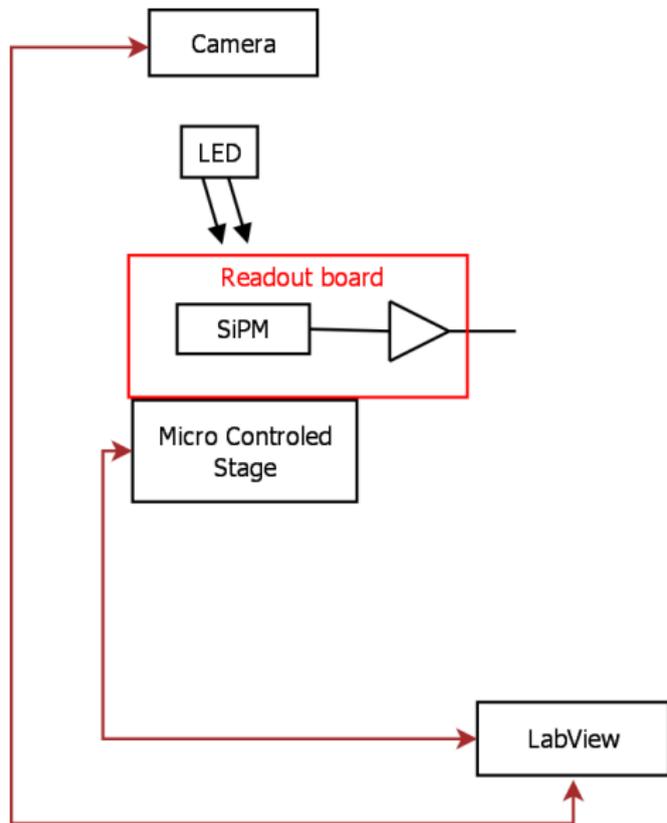
Block scheme

Measurement process



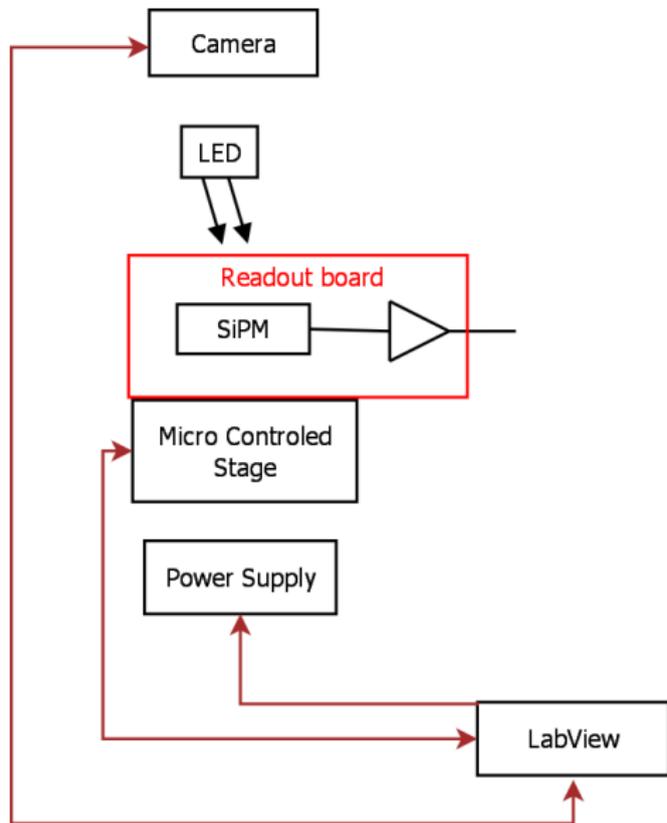
Block scheme

Measurement process



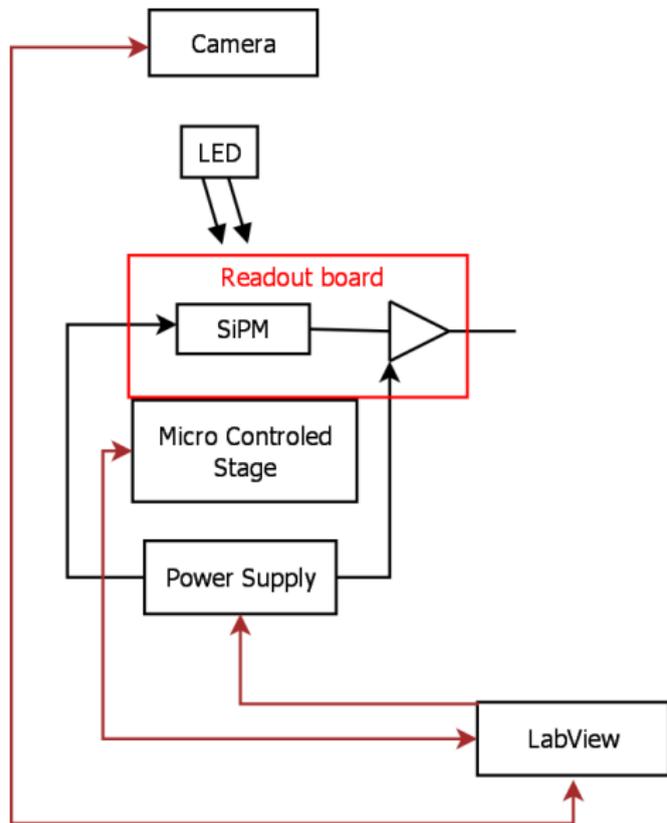
Block scheme

Measurement process



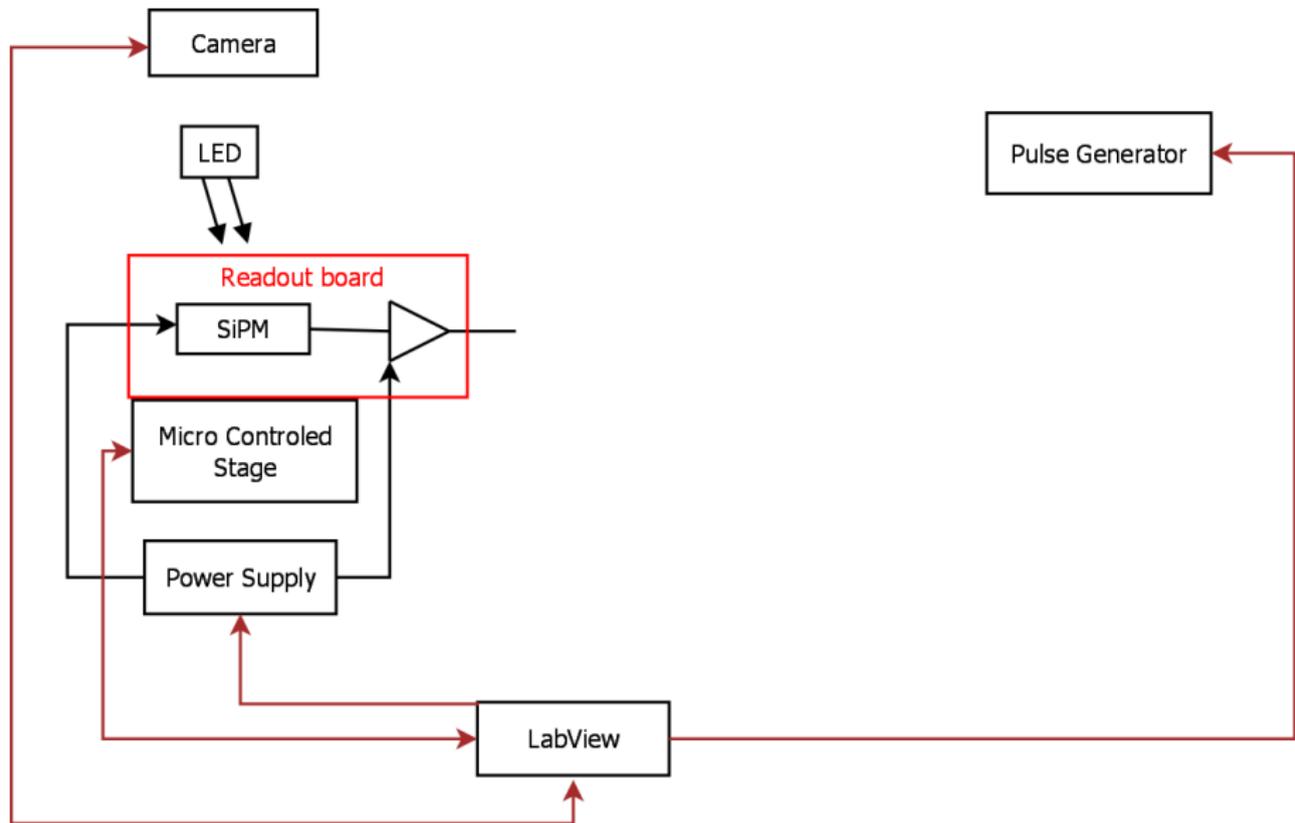
Block scheme

Measurement process



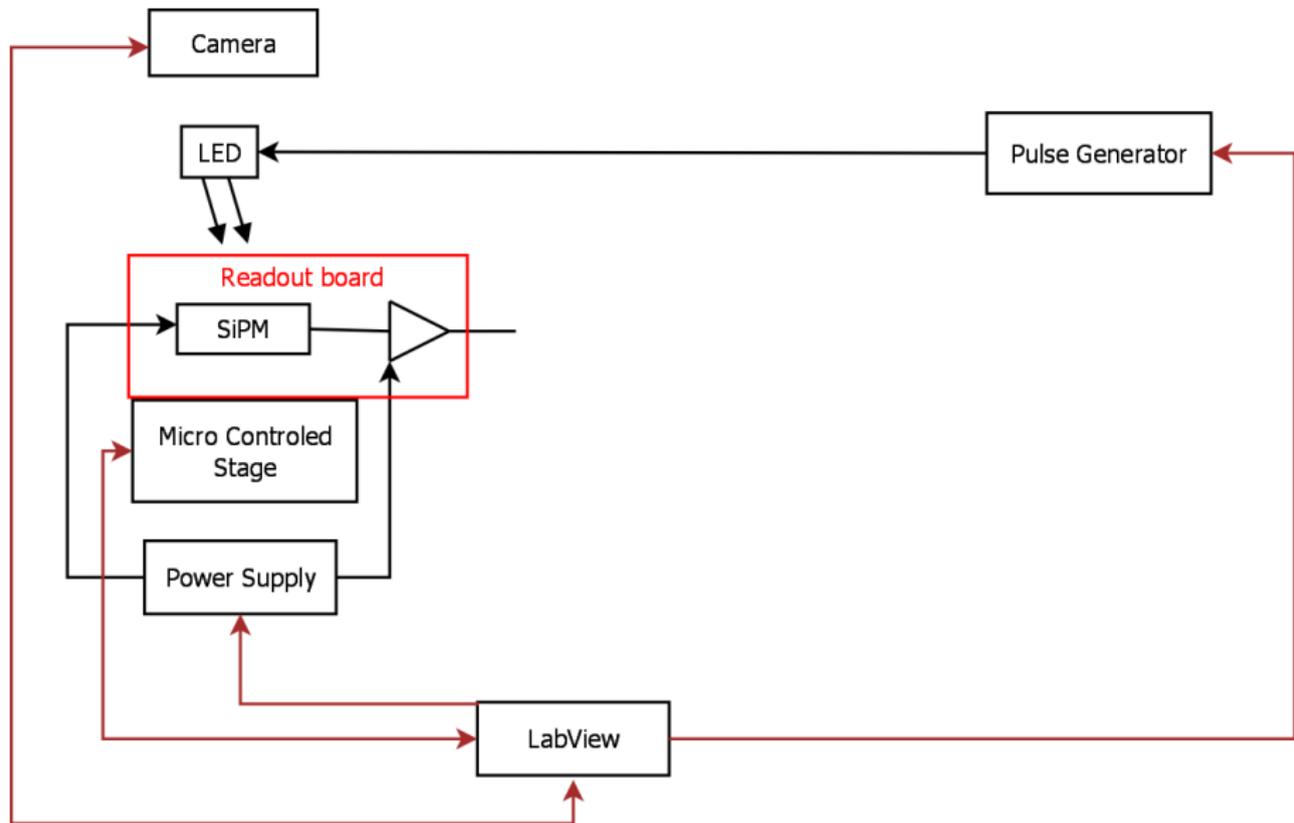
Block scheme

Measurement process



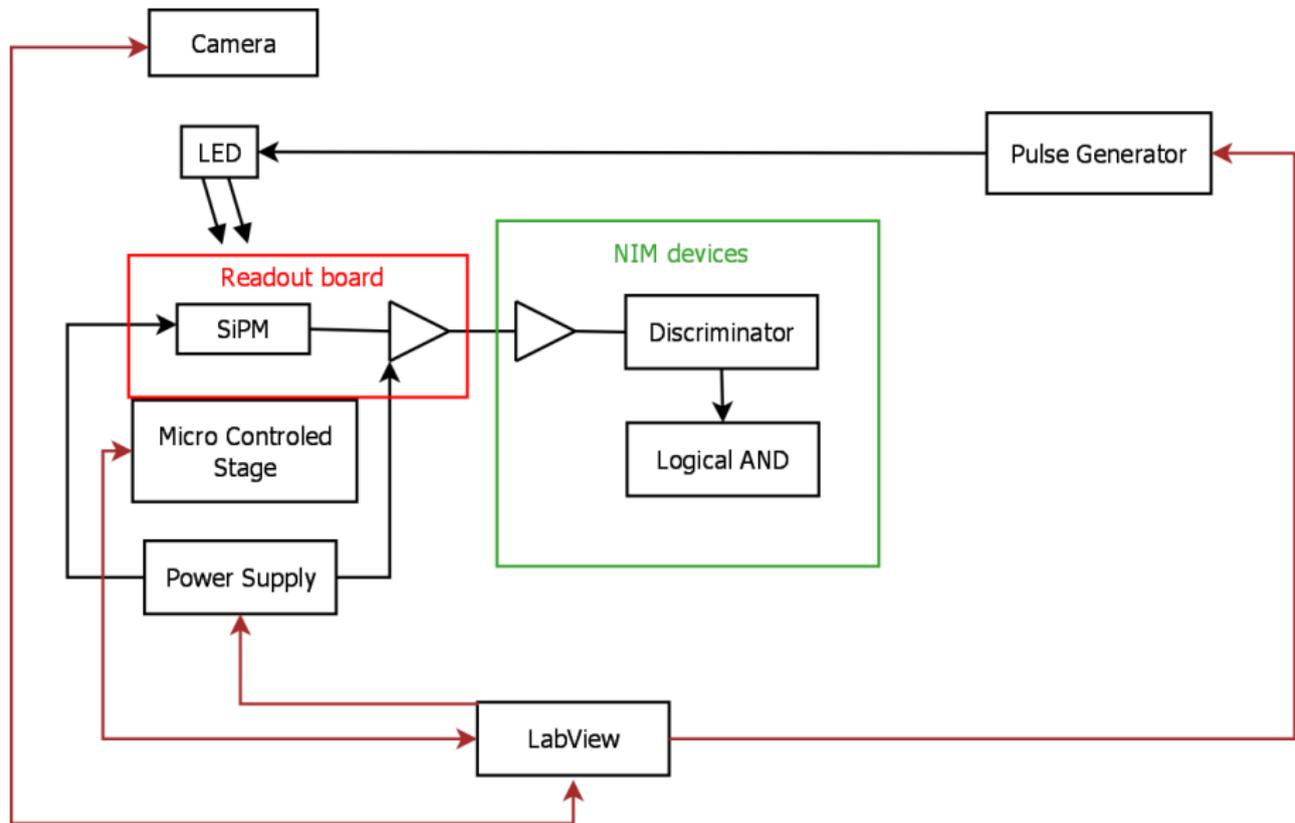
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Measurement process



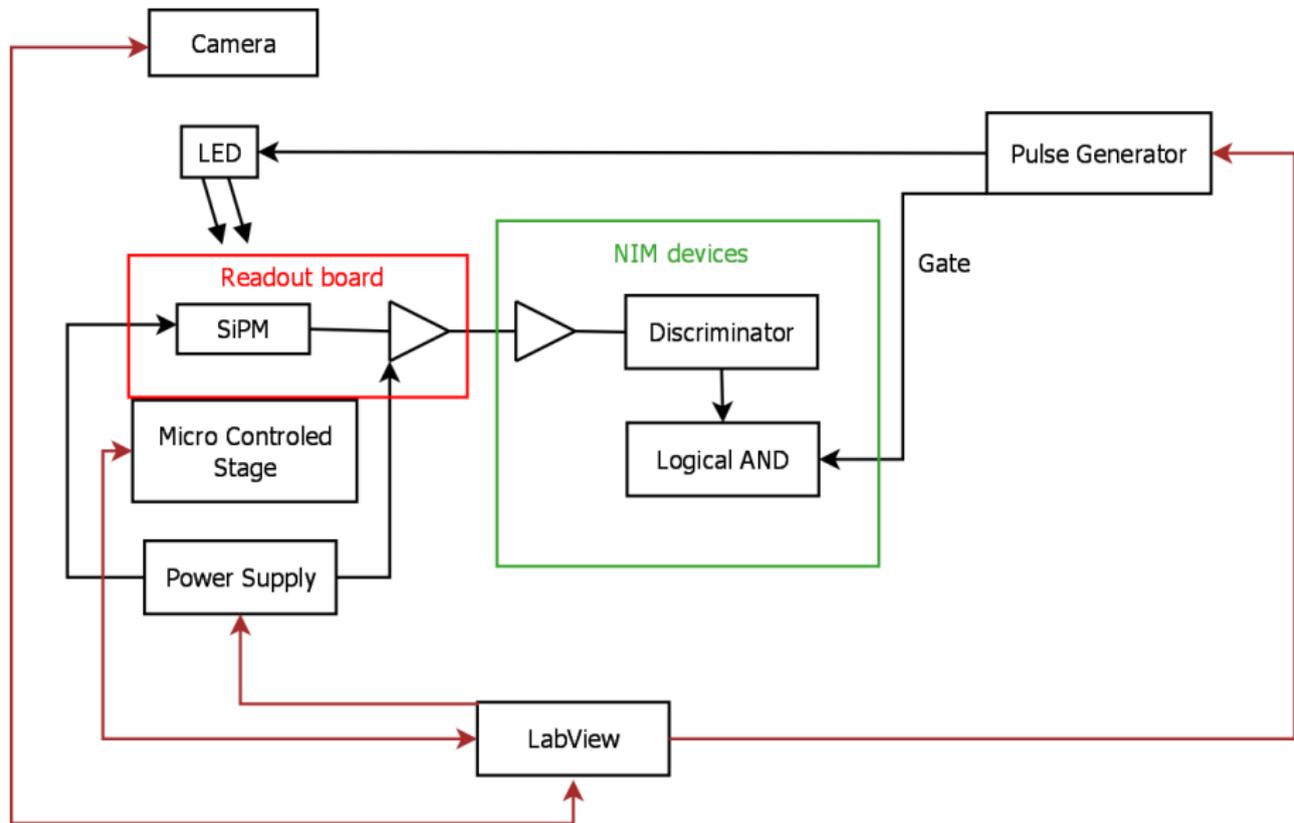
Block scheme

Measurement process



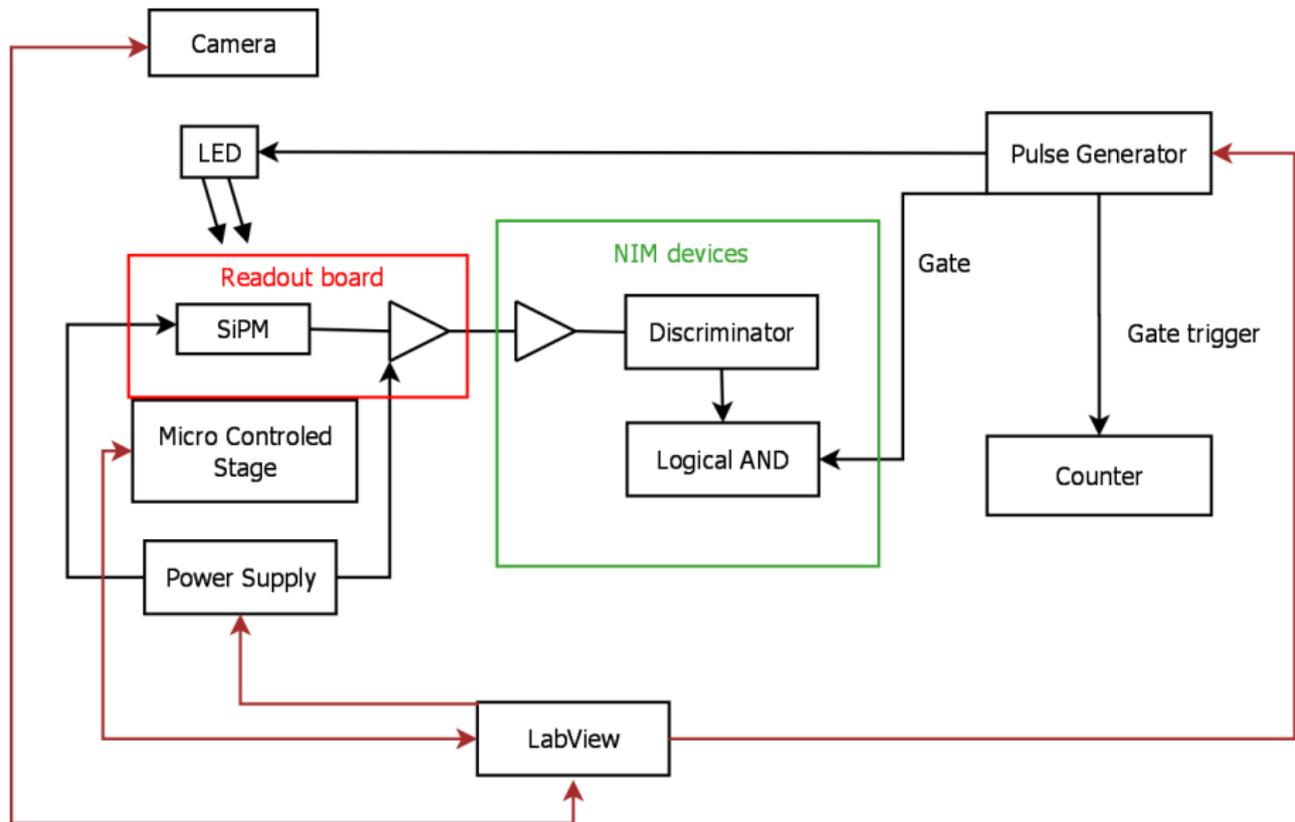
Block scheme

Measurement process



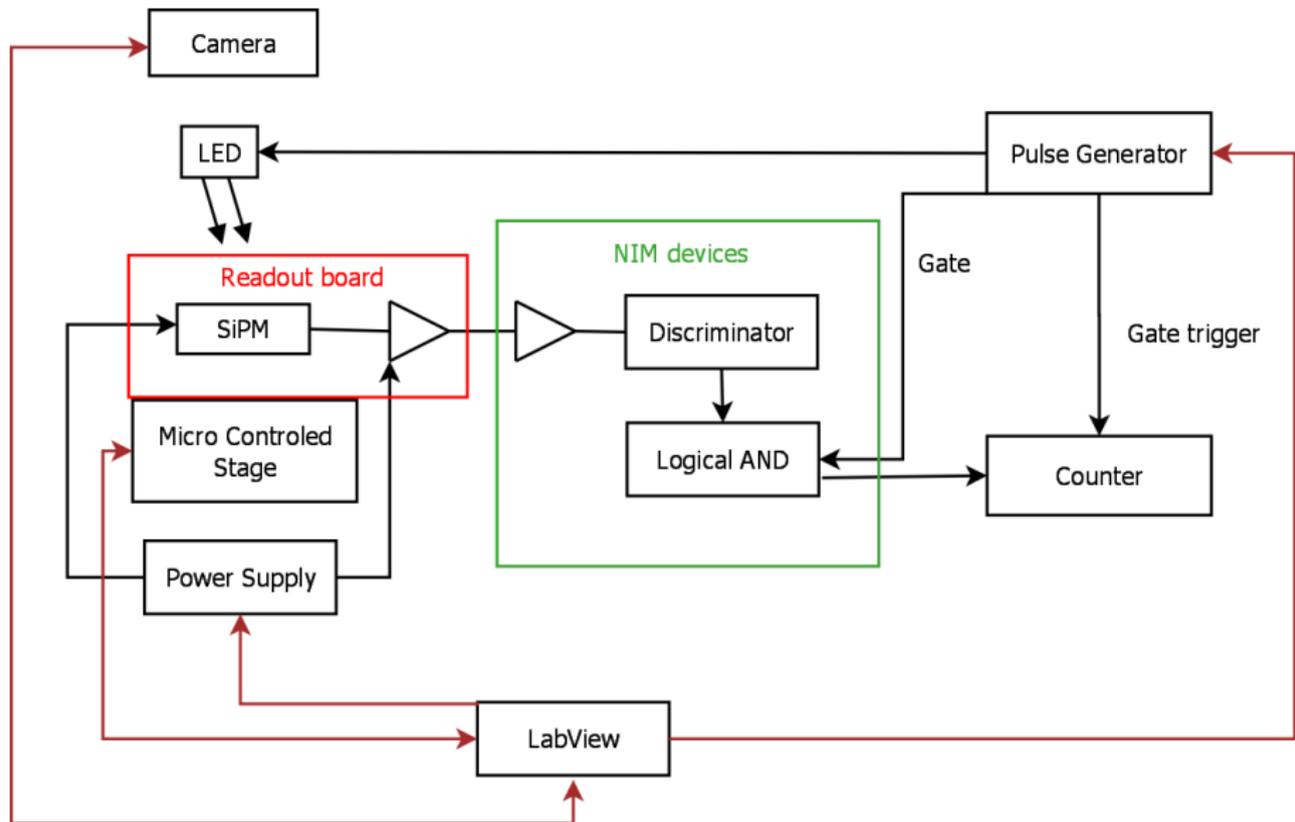
Block scheme

Measurement process



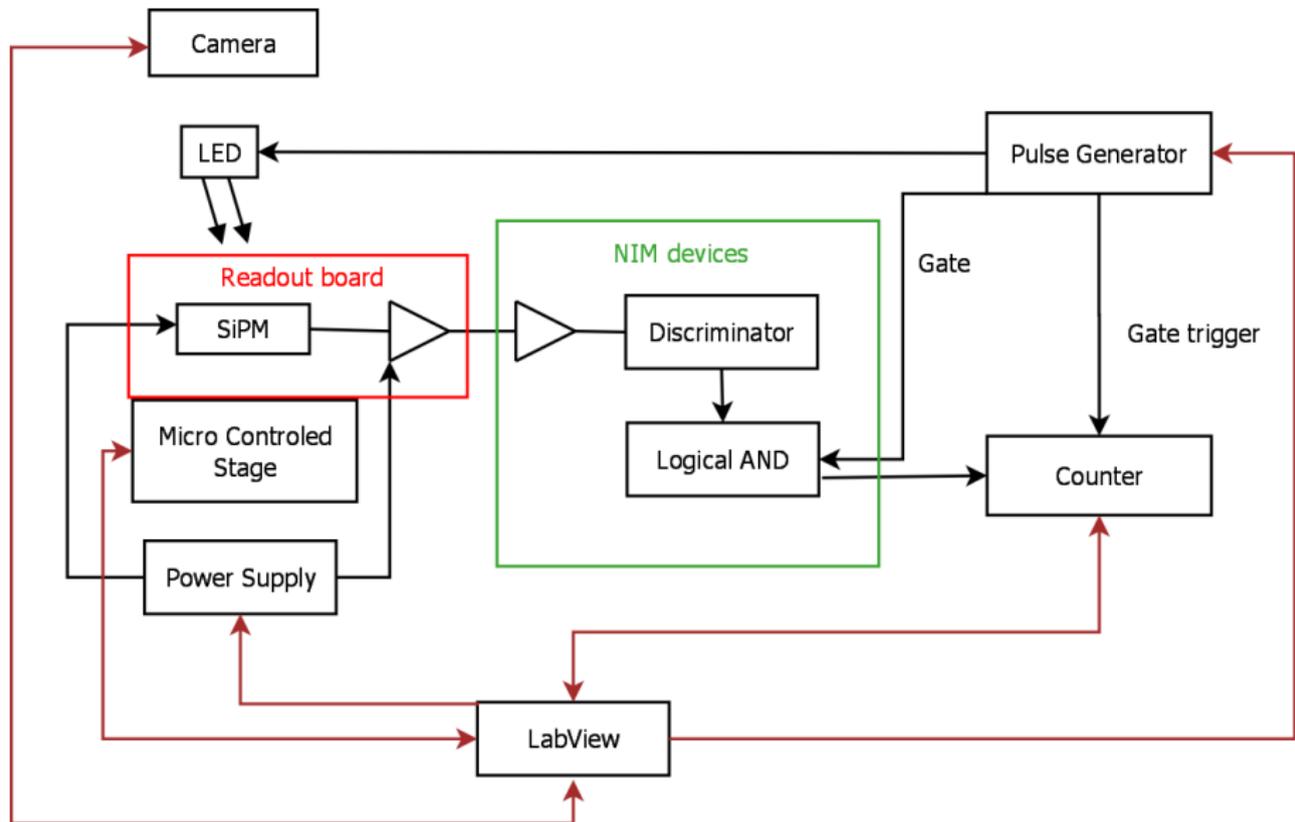
Block scheme

Measurement process



Block scheme

Measurement process



Quantities of interest

⇒ first of all, noise is determined and subtracted

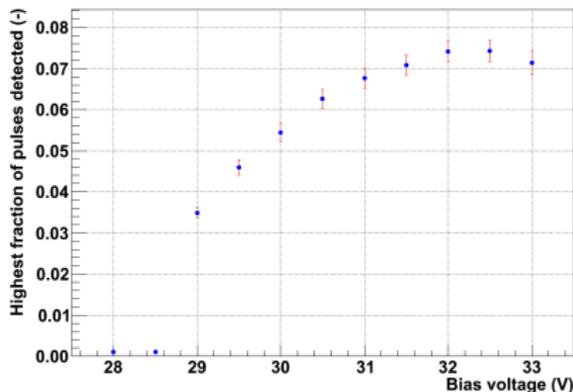
Quantities of interest

- noise
- fill factor (can be obtained separately for a single microcell)
- uniformity of efficiency over the device
- photon detection efficiency ★
- ★ normalisation with other absolute measurement needed
- + bias voltage dependencies

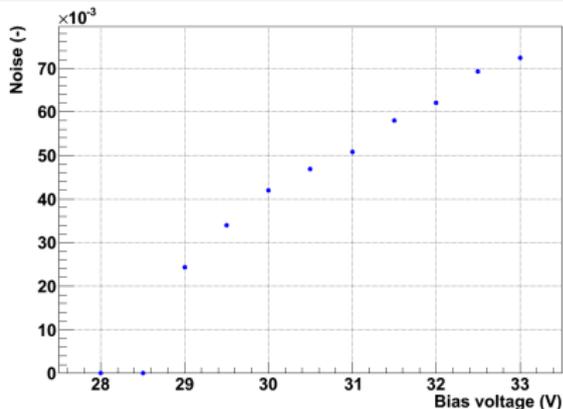
Bias voltage dependencies

- can be used as a cross check of stage calibration (LED focus), correct settings of thresholds etc.
- shows when quenching ceases
- possible later comparison of different wavelengths (further improvements needed)

Highest fraction of pulses detected: SENSI, blue LED



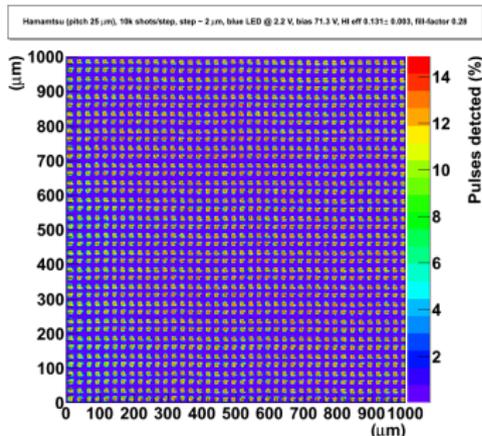
Noise: SENSI, blue LED



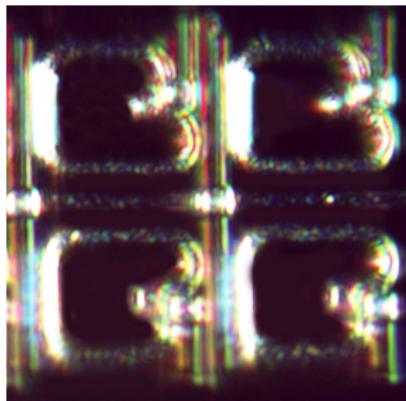
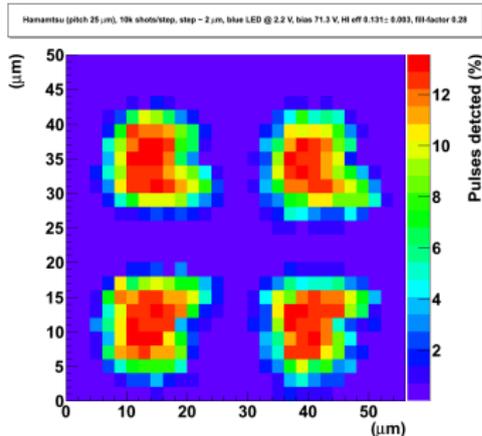
manufacturer	type	pixel pitch (μm)
Hamamatsu	S10362-11-025U, C	25
Hamamatsu	S10362-11-050U, C	50
Hamamatsu	S10362-11-100U, C	100
SENSI	SPMMicro1035X13	35
SENSI	SPMMicro1100X13	100
MEPhI/Pulsar	SiPM576#1	32
MEPhI/Pulsar	N/A	42

Table: Devices available for tests in MPI HLL

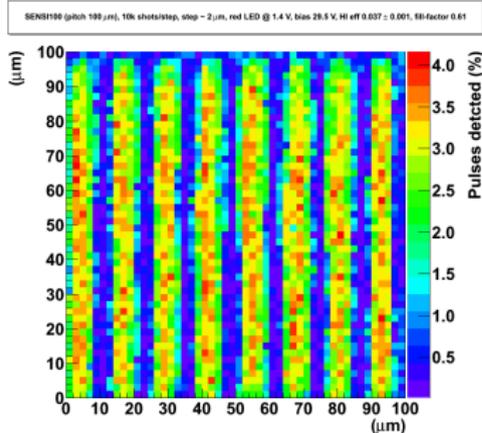
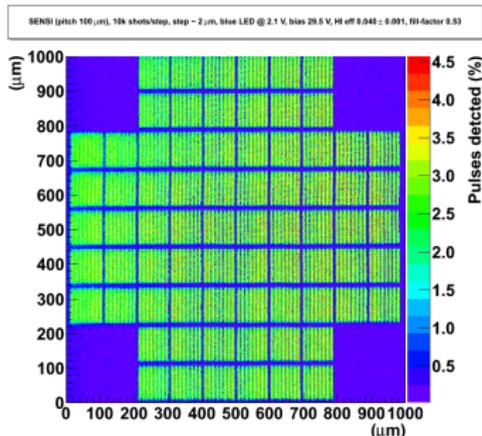
Results: Hamamatsu (MPPC) (25 μm pitch)



sensitive area is obviously significantly reduced by the quenching resistor placed on surface of the device

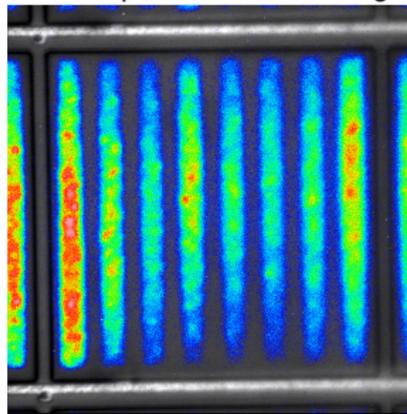


Results: SENSI (100 μm pitch)



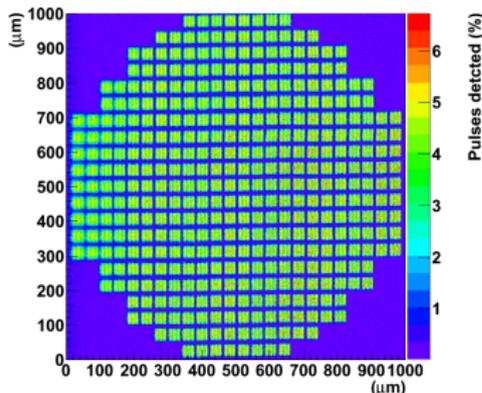
different quenching resistor shape can be observed on the sensitivity map

Photo + photoemission image

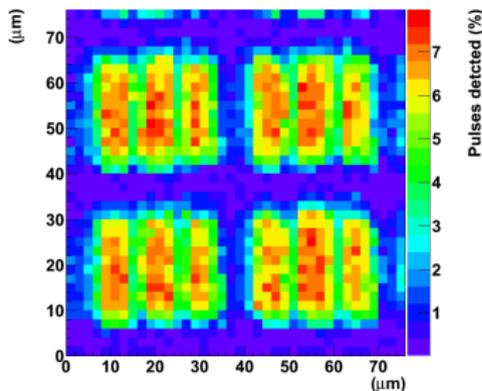


Results: SENSI (35 μm pitch)

SENSI (pitch 35 μm , 10k shots/step, step = 2 μm , blue LED @ 2.2 V, bias 31.0 V, HI eff 0.659 : 0.661, HI-factor 0.43

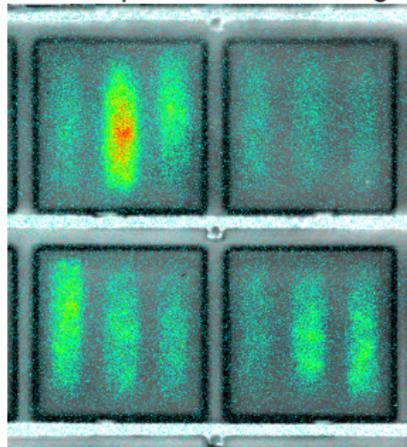


SENSI (pitch 35 μm , 10k shots/step, step = 2 μm , blue LED @ 2.2 V, bias 31.5 V, HI eff 0.071 : 0.082, HI-factor 0.49



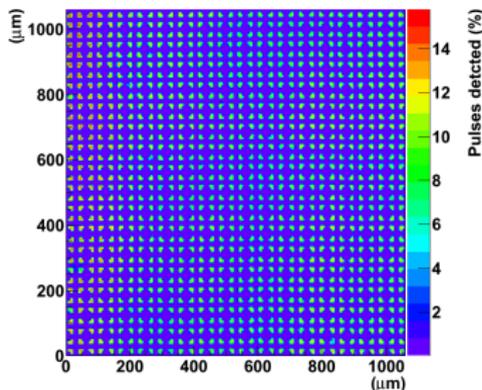
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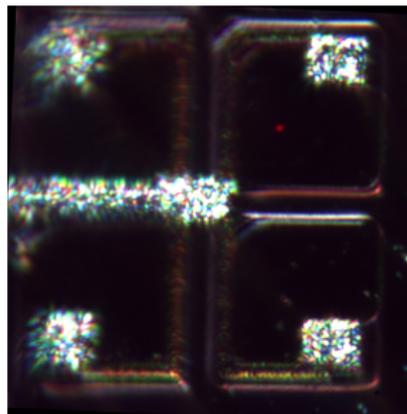
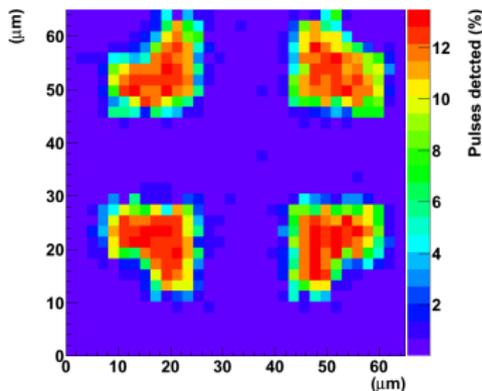
Results: MEPhi (Dolgoshein) (32 μm pitch)

Dolgoshein (pitch 32 μm), 10k shots/stop, step - 2 μm , blue LED @ 1.4 V, bias 90.0 V, HI eff 0.138 : 0.064, BR-factor 6.19



different quenching resistor shape can be observed on the sensitivity map

Dolgoshein (pitch 32 μm), 10k shots/stop, step - 2 μm , red LED @ 1.4 V, bias 80.0 V, HI eff 0.123 : 0.005, BR-factor 0.24



Accomplished

- new stage calibration developed
 - new scanning procedure applied
 - higher level of automation reached
- ⇒ scanning time reduced by three orders of magnitude
- ⇒ capability of scanning arbitrarily aligned SiPM surfaces

Future plans

- optimisation of data analysis
- scans of further devices
- normalisation with an absolute measurement
- light output estimation of used LEDs